

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

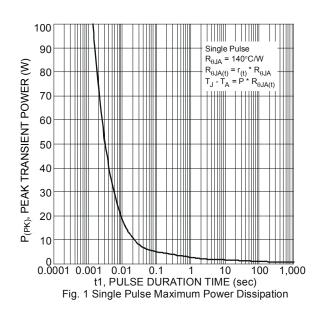
Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	۱ _D	10.5 8.5	А
	t<10s	T _A = +25°C T _A = +70°C	۱ _D	14 11	А
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)			I _{DM}	90	A
Maximum Continuous Body Diode Forward Current (Note 6)			I _S	3.0	A
Avalanche Current (Note 7) L = 0.1mH			I _{AR}	22	A
Repetitive Avalanche Energy (Note 7) L = 0.1mH			E _{AR}	24	mJ

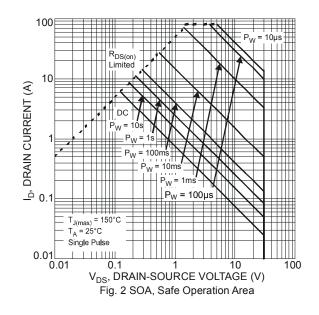
Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	Steady State	D	0.9	W
	t<10s	PD	1.5	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	P	142	°C/W
	t<10s	$R_{ extsf{ heta}JA}$	78	
Total Power Dissipation (Note 6)	Steady State	D-	2.2	W
	t<10s	PD	3.5	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	P	59	°C/W
mermal Resistance, sunction to Amplent (Note 6)	t<10s	$R_{ extsf{ heta}JA}$	33	
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	11	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

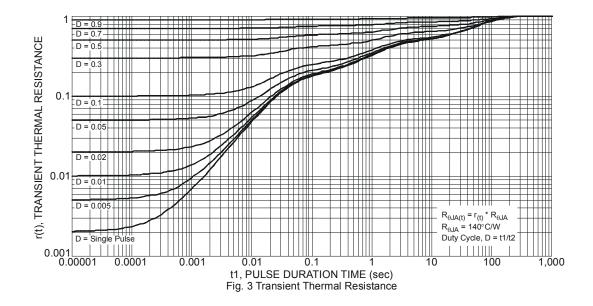
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

7. I_{AR} and E_{AR} ratings are based on low frequency and duty cycles to keep T_J = +25°C.







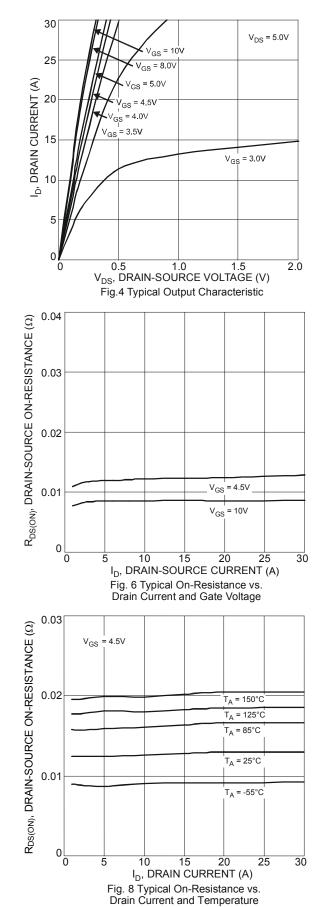


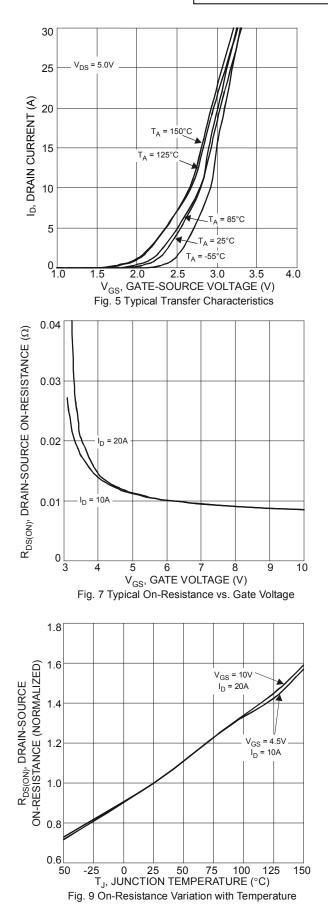
Electrical Characteristics (@ TA =	+25°C, unless otherwi	se specifi	ed.)			
Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						÷
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	I _{DSS}	—	—	1	μA	V _{DS} = 30V, V _{GS} = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						÷
Gate Threshold Voltage	V _{GS(th)}	1.4	—	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance		_	7	11	mΩ	V _{GS} = 10V, I _D = 20A
Static Drain-Source On-Resistance	R _{DS(on)}		11	15		V _{GS} = 4.5V, I _D = 20A
Forward Transfer Admittance	Y _{fs}	—	74	—	S	V _{DS} = 5V, I _D = 20A
Diode Forward Voltage	V _{SD}	_	0.75	1.0	V	V _{GS} = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS (Note 9)						÷
Input Capacitance	C _{iss}	—	1281	—	pF	
Output Capacitance	C _{oss}	—	145	—	pF	└ V _{DS} = 15V, V _{GS} = 0V, _ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	—	125	—	pF	
Gate Resistance	Rg	—	1.2	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	12.5	—	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	—	26.7	—	nC	
Gate-Source Charge	Q _{gs}	_	3.6	_	nC	V _{DS} = 15V, I _D = 12A
Gate-Drain Charge	Q _{gd}		4.4	_	nC	1
Turn-On Delay Time	t _{D(on)}	_	5.2	_	ns	
Turn-On Rise Time	t _R	_	21.2	_	ns	V _{DD} = 15V, V _{GS} = 10V,
Turn-Off Delay Time	t _{D(off)}	_	22.3	—	ns	R _L = 1.25Ω, R _G = 3Ω
Turn-Off Fall Time	t _F	—	5.1	_	ns	1
Reverse Recovery Time	t _{RR}	—	8.5	—	ns	I _F = 12A, di/dt = 500A/µs
Reverse Recovery Charge	Q _{RR}	—	7.0	—	nC	I _F = 12A, di/dt = 500A/µs

 8. Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to product testing. Notes:



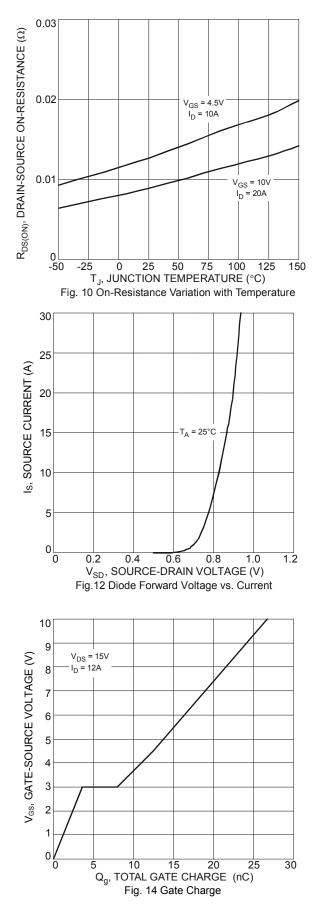
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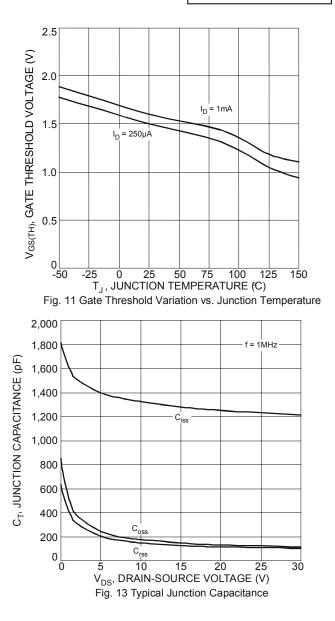




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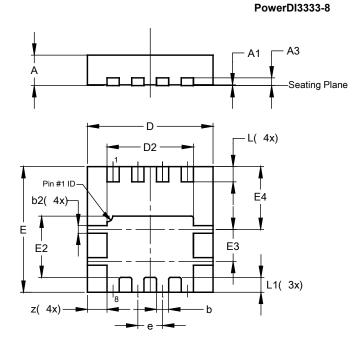






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

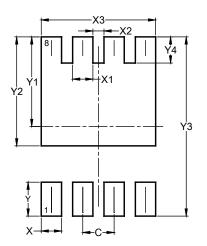


PowerDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	-	-	0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
E	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
е	_	_	0.65		
L	0.35	0.45	0.40		
L1	-	-	0.39		
z	-	_	0.515		
All I	All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
X3	2.370
Y	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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